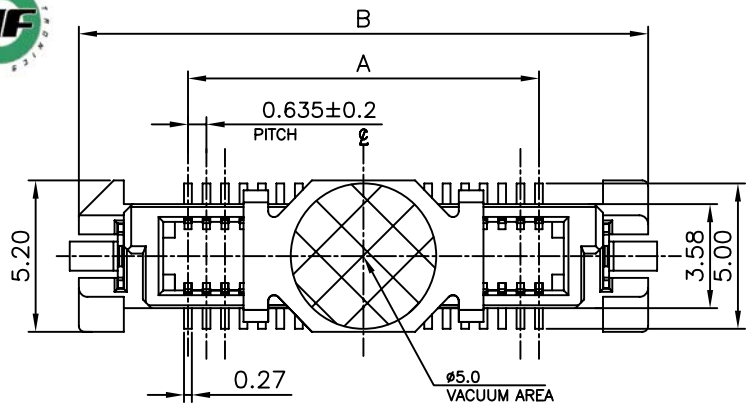
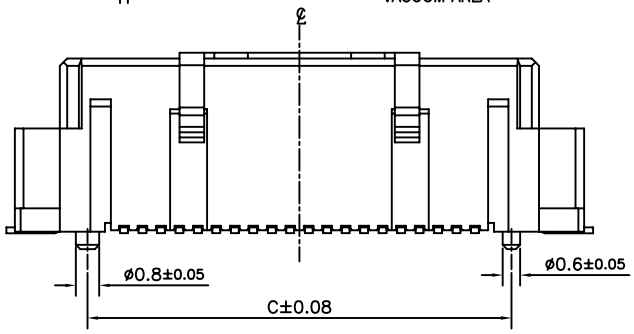
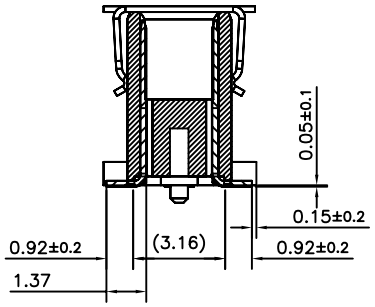
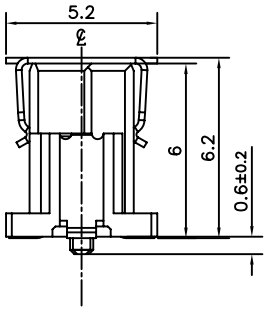




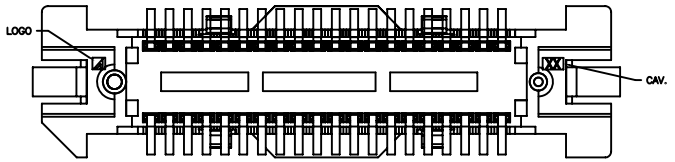


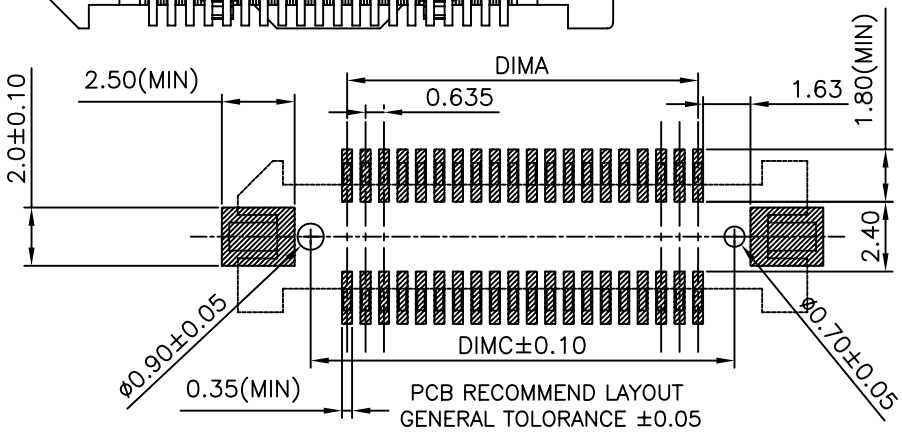
DETAL FOR SOLDERING AREA



NOTES:
1. MATERIAL:
   1.1 HOUSING: LCP,UL94V-0, UL-POLYPLASTICS-LCP(E473i)(BK)
   1.2 CONTACT: C2680-H(T=0.2).
   1.3 FITTING NAIL: C2680-H(T=0.2).
   1.4 VACUUM COVER:SUS304-1/2H(T=0.2)
2. FINISH:
   2.1 CONTACT:
      8: 50u" MIN NICKEL OVERALL.
         10u" MIN GOLD ON CONTACT AREA
   2.2 SOLDER:
      8:50u" MIN NICKEL OVERALL.
         40u"MIN MATT TIN PLATING ON SOLDER AREA.
   2.3 FITTING NAIL:
      N:50u" MIN NICKEL OVERALL.
         50u"MIN MATT TIN PLATING ON OVER ALL.
3. TAILS COPLANARITY TO BE 0.1MAX
4. REFLOW SOLDER CAPABLE TO 260°C
   PER ACES SPEC.
5. SPEC.PLS REFER TO PS-51153-XXXXX-XXX
6. PACKAGE PLS REFER TO 51152-XXXXX-XX-TRP
7. PART NUMBER

51152-XXX X X-XXX
- XXX: CKTS
- X: PACKING
  7:TAPE&REEL WITH COVER
- X-XXX: PLATING
  8: 10u" MIN GOLD ON CONTACT AREA
     40u" MIN MATT TIN ON SOLDER AREA
- 001:NONE





CKT	A	B	C
40	12.065	19.57	14.57

一般公差
TOLERANCES
X ±0.5 .XX ±0.15
.X ±0.25 .XXX ±0.1
ANGLES ±2°

檢驗尺寸標示
SYMBOLS Ⓒ Ⓜ INDICATE CLASSIFICATION DIMENSION
Ⓒ MARK IS CRITICAL DIM.
Ⓜ MARK IS MAJOR DIM.

表面處理 (FINISH)

宏致電子股份有限公司
Aces Electronics Co.,Ltd.

品名 (TITLE): 0.635mm pitch BTB Plug conn SMT D/R S/T Type

圖號 (DWG NO.): 51152-XXXXX-XXX

製圖 (DR): 17'/08/08 YZQ

審核 (CHKD): BRAVE

核准 (APPD): FRANK

比例 (SCALE): 1:1

單位 (UNITS): mm

張數 (SHEET): 1 OF 1

SIZE: A4

REV: 0